## **Key Features :**

- Frequency range : 0.1 6GHz
- Insertion loss : 0.5dB
- Isolation : 40dB
- Input/output standing wave : 1.5/1.5
- Input P-0.3 : 45dBm
- Switching time : 20ns
- Control method : 0/-40V
- Chip dimensions : 1.35mm x 1.20mm x 0.1mm
- Applications : wireless communication, transceiver module, radio telecommunication etc.

## **Description :**

AMSW0021S chip is a reflection SPDT switch chip (MMIC), the design is based on Gallium Nitrate (GaN) HEMT process, with ground through metal via on the back technology. All chip products are 100% RF tested. The chip uses 0V, -40V level control, typical insertion loss 0.5dB, isolation 40dB, Input/Output VSWR 1.5.

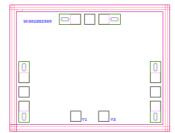
## **Absolute Maximum Ratings**

Symbol	Parameter	Value	Remark	
V1, V2	Control Voltage	0.6V/-50V		
Pin	Input Power	46dBm		
Tm	Sintering Temperature	310 °C	30s, N <sub>2</sub> protection	
Tstg	Storage Temperature	-65 ~ +150 °C		

[1] Operation outside any of the Absolute Maximum Ratings may cause permanent device damage.

#### Electrical Characteristics (Ta = 25°C)

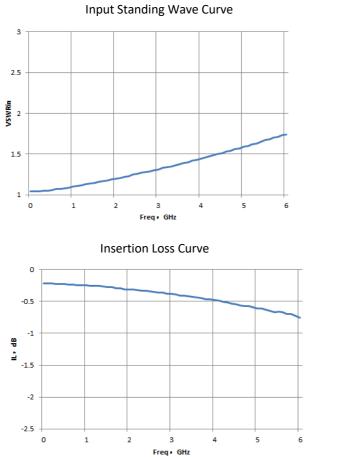
Symbol	Parameter	Test Condition	Value		Unit	
			Min	Typical	Max	
VSWRin	Input Standing Wave		-	1.5	1.8	
VSWRout	Output Standing Wave	F : 0.1 – 6GHz	-	1.5	1.6	
IL	Insertion Loss		-	0.5	0.8	dB
ISO	Isolation		31	40	-	dB



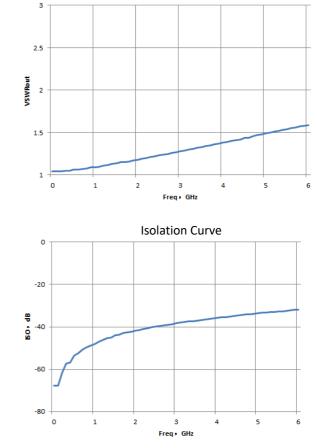
0.1 – 6GHz SPDT Switch Chip

AMT2302

## AMT2302 0.1 – 6GHz SPDT Switch Chip



### **Typical Performance**

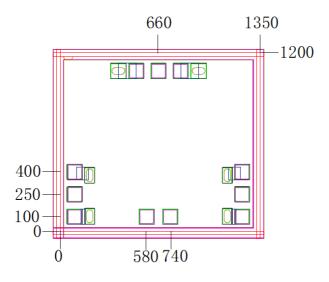


**Output Standing Wave Curve** 

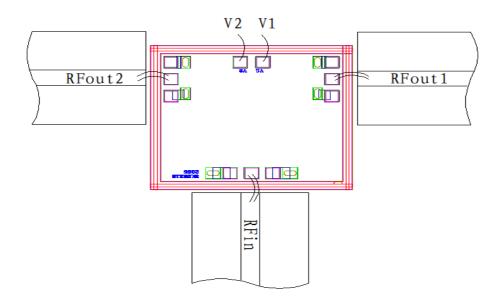
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# AMT2302 0.1 – 6GHz SPDT Switch Chip

## Chip Dimension (Unit : µm)



### **Chip Layout Diagram**



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## AMT2302 0.1 – 6GHz SPDT Switch Chip

## **Pad Definition**

Pad No.	Symbol	Function	Dimension
1	RF_in	RF signal input port, connecting to external 50 $\Omega$ system, no need to add	100*100µm²
		DC blocking capacitor.	
2	RF_out1	RF signal output port 1, connecting to external 50 $\Omega$ system, no need to	100*100µm²
		add DC blocking capacitor.	
3	RF_out2	RF signal output port 2, connecting to external 50 $\Omega$ system, no need to	100*100µm²
		add DC blocking capacitor.	
4	V1	Supply control port, refer to the Truth Table for its control logic.	100*100µm²
5	V2	Supply control port, refer to the Truth Table for its control logic.	100*100µm²

### **Truth Table**

	V1	V2
RF_in – RF_out1	-40V	0V
RF_in – RF_out2	0V	-40V

Please see Appendix A for details.

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